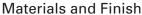
Insulation Resistance:  $100M\Omega$  at 100 V DC for 1 minute

**Current Rating:** 1A max. per contact 100V ACrms max. Voltage Rating: Withstanding Voltage: 500V AC for 1 minute

**Contact Resistance:**  $50m\Omega$  max. at 20mV max. / 100mA max. Part Number

USB-M05-003



Housing: PA 6T, glass filled (UL94V-0) Shell: Copper Alloy, Tin over Cu

Contacts: Copper Alloy

Contact Plating: Solder area - Tin over Ni

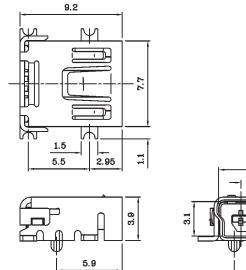
Mating area - 30µ" Au over Ni

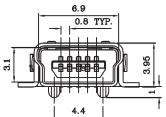


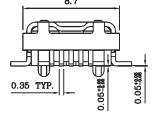
#### **Features**

According to Hi-Speed USB standard, data transmission rate up to 480 Mbit / sec

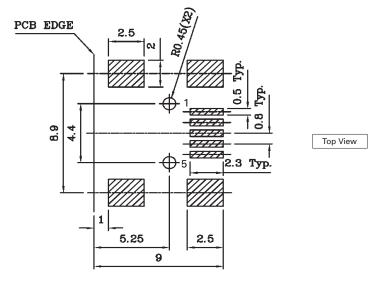
### Outline Dimensions SMT Type







## Recommended PCB Layout





## Series USB-M Mini USB - Plug (5 Pin Solder Port )



## Specifications

Insulation Resistance: 100M $\Omega$  at 100 V DC for 1 minute

Withstanding Voltage: 100V AC for 1 minute 30V ACrms max. Voltage Rating: **Current Rating:** 1A max. per contact

Contact Resistance:  $30m\Omega$  max. at 20mV max. / 100mA max.



## Part Number

### USB-M05-P

USB-M05-P is only available in assembled versions with moulded strain relief. For more details please contact Yamaichi.



Photo showing plug without plastic molding

### Materials and Finish

Shell: Ni plated over Copper

Housing: Thermoplastic, glass filled (UL94V-0)

Contacts: Copper Alloy

Contact Plating: Mating area - 30µ" Au over Nickel

# **Features**

- Premating contacts to secure data protection when hot plug / unplug
- According to Hi-Speed USB standard, data transmission rate up to 480 Mbit / sec



## Outline Dimensions Plug

